

Fig. 1

The diagram shows a top-down view of a multi-channel electronic device, labeled 10. The device consists of a rectangular printed circuit board (PCB) with four vertical channels. Each channel contains a series of components labeled T1, T2, T3, TN, N1, N2, N3, NN, E1, E2, E3, and EN. A large component 38 is located on the left side of the board. A component 36 is located on the right side of the board. Various other components are labeled with 32, 34, 40, and 20.

Fig. 2

FIG. 3 is a perspective view of the assembly of the present invention, showing the exploded view of the components of the assembly.

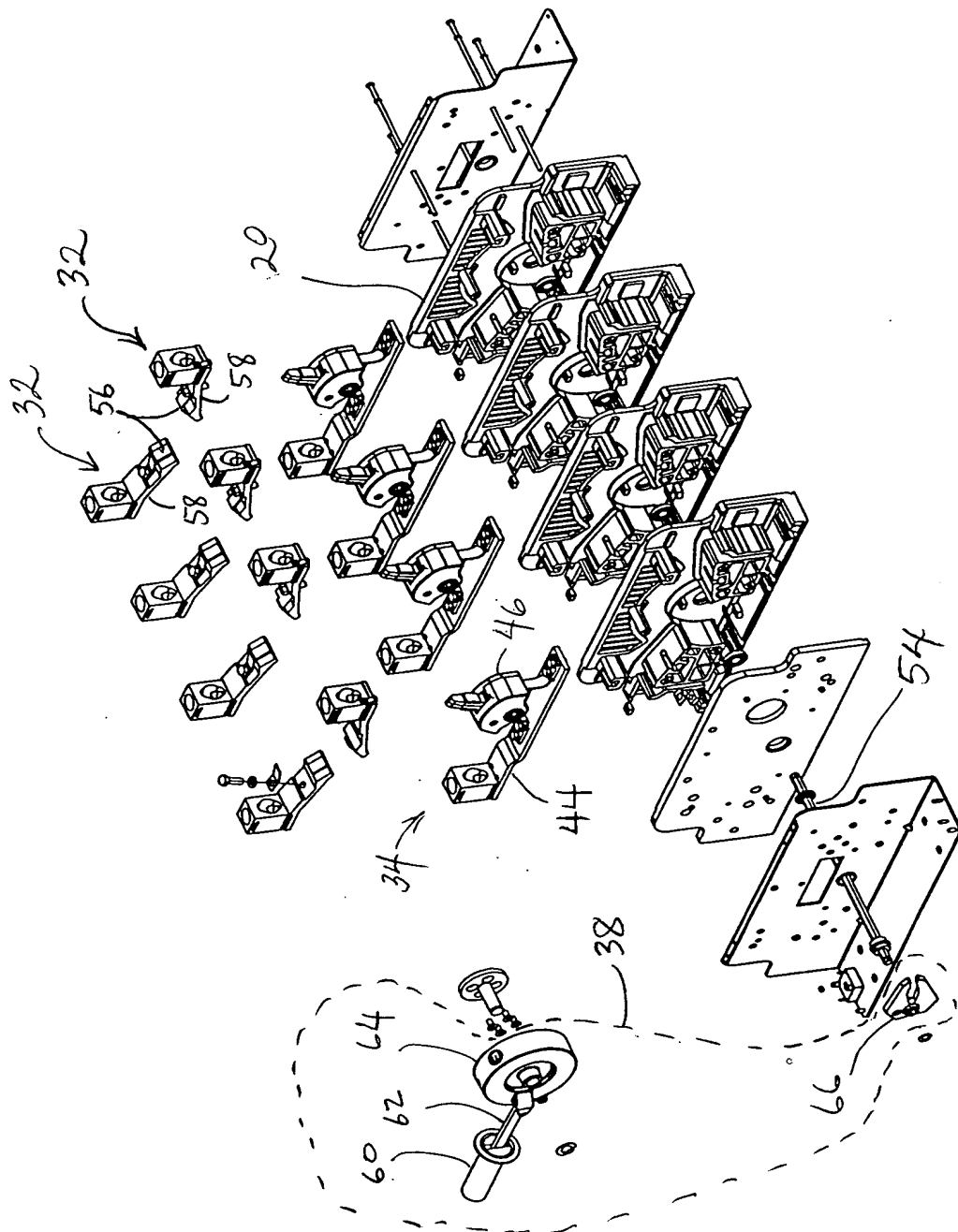


Fig. 3

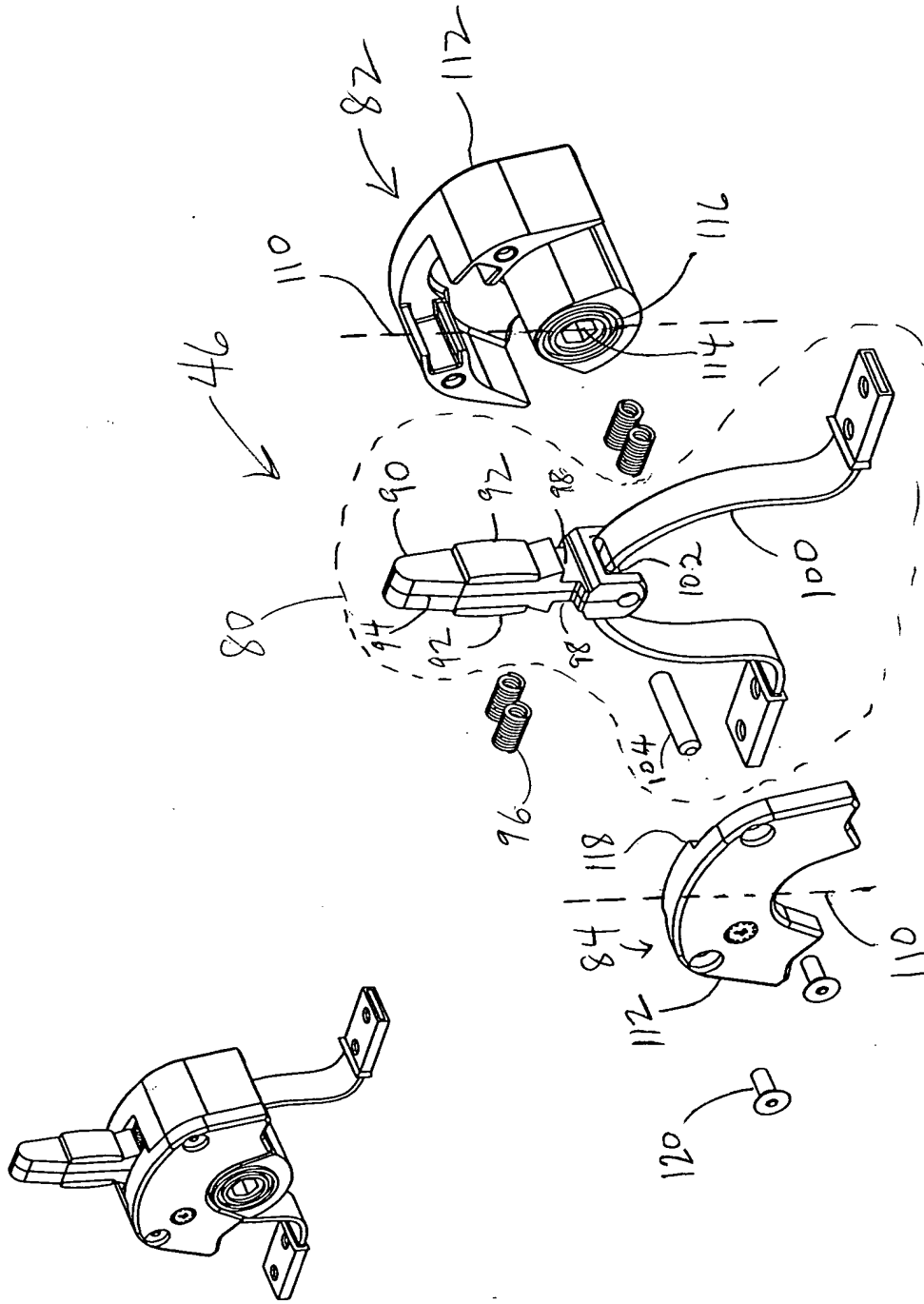


Fig. 5

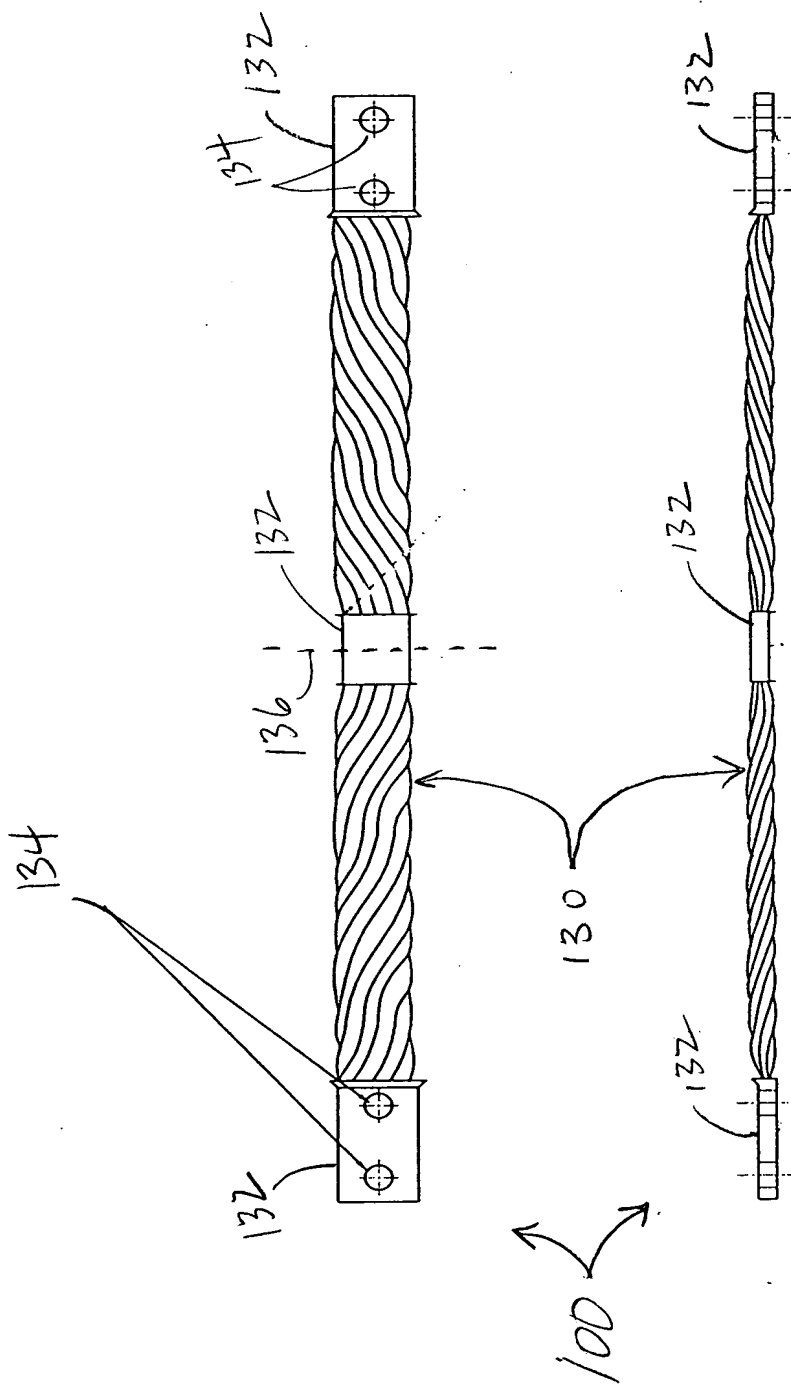


Fig. 6

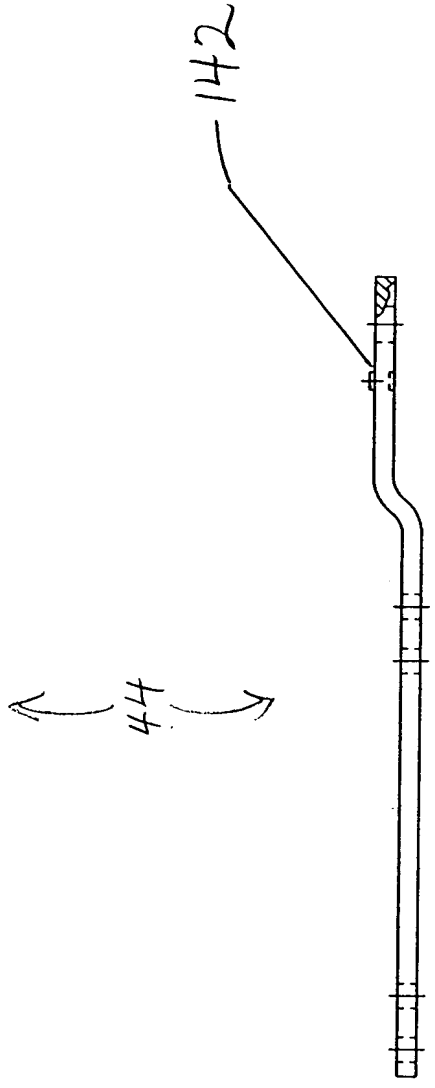
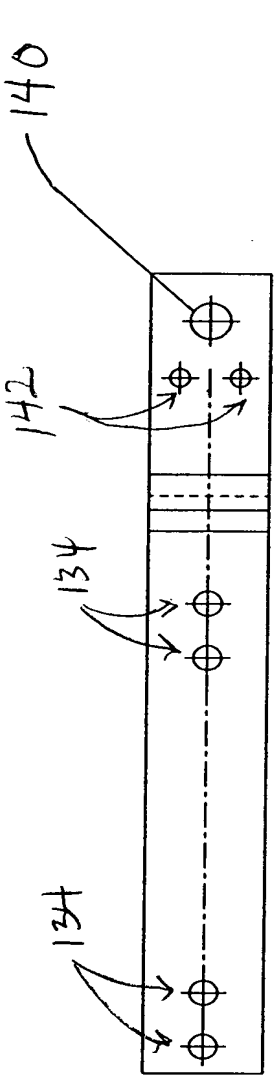
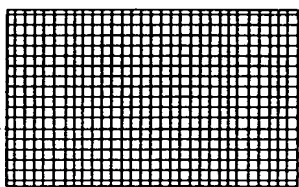


Fig. 7

92
↑



92
↑

150



Fig. 8

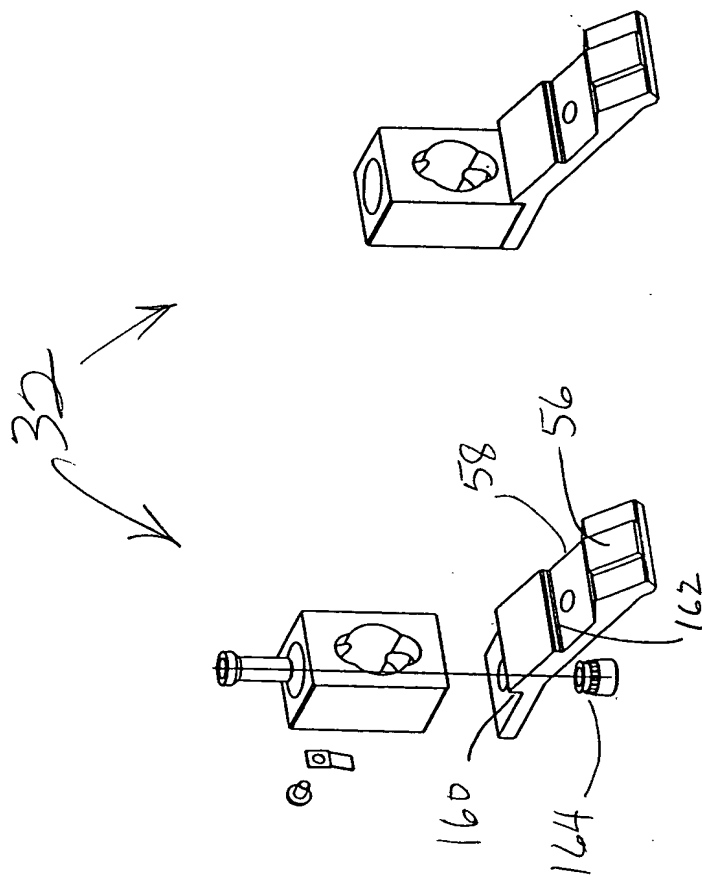


Fig. 9

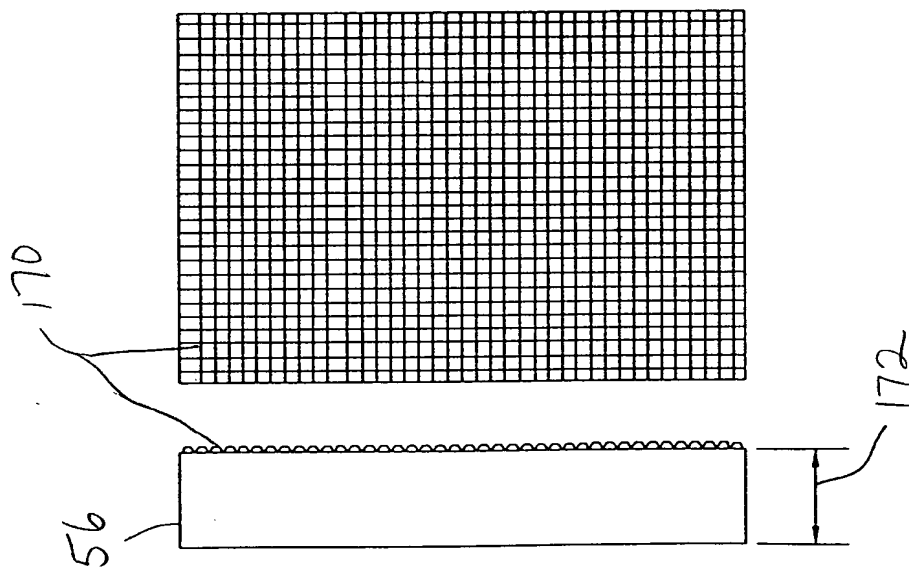


Fig. 10

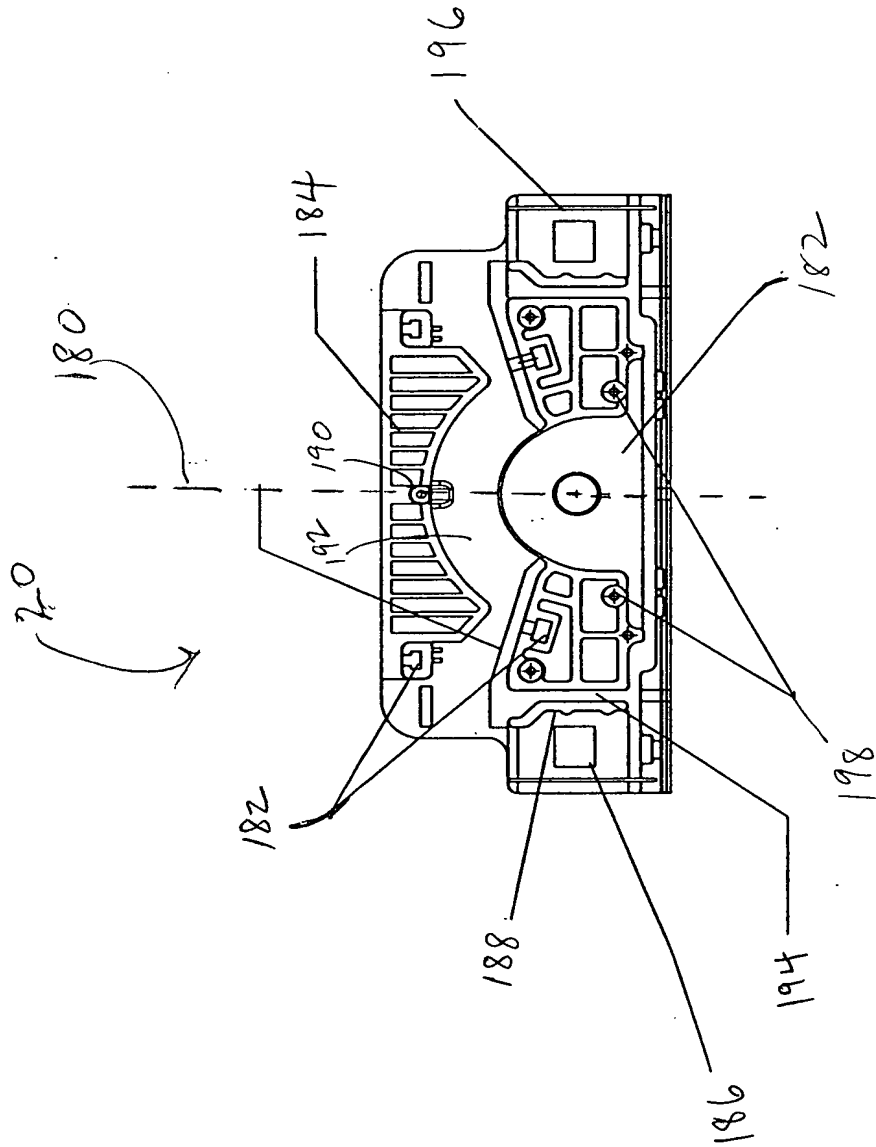


Fig. 11

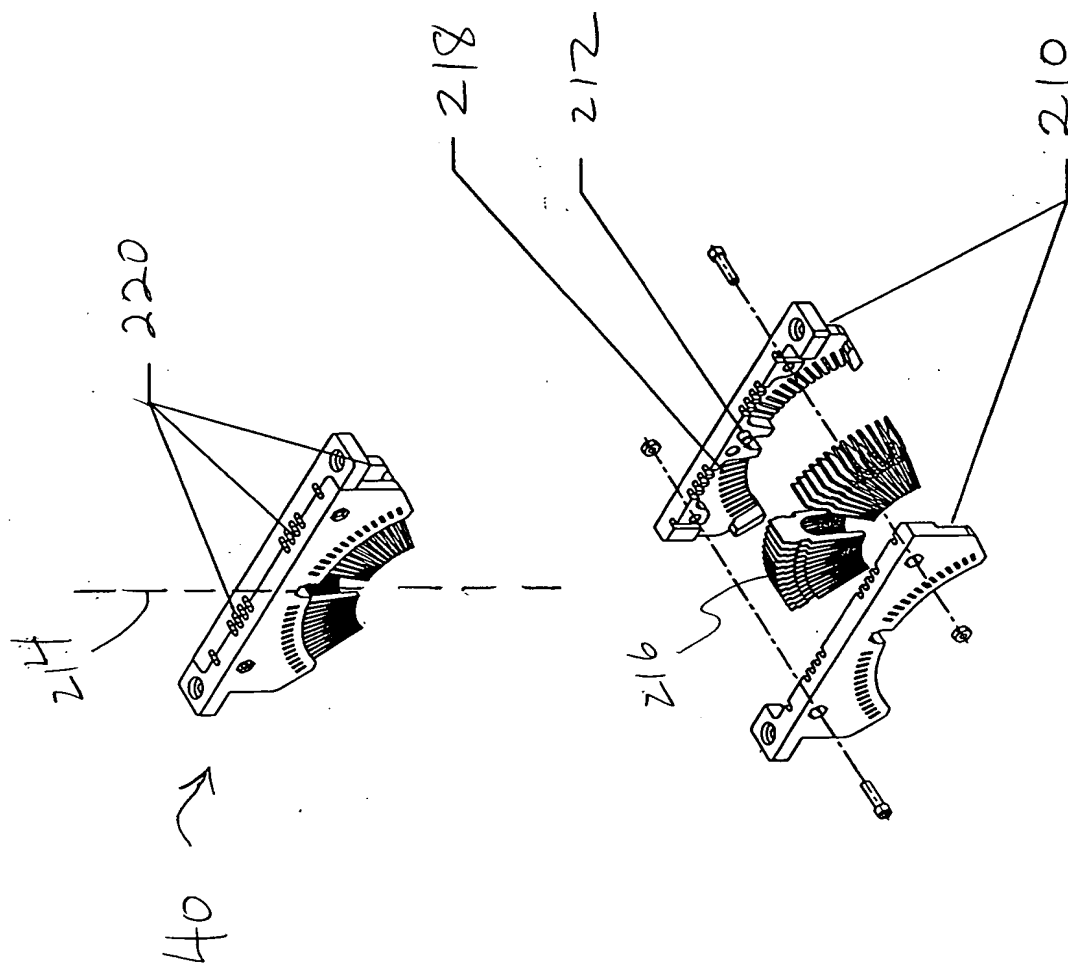


Fig. 12

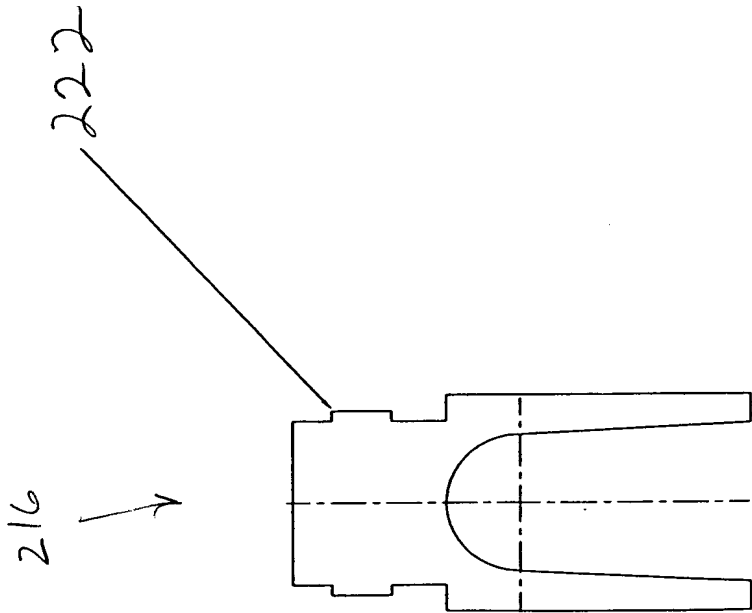


Fig. 13

38

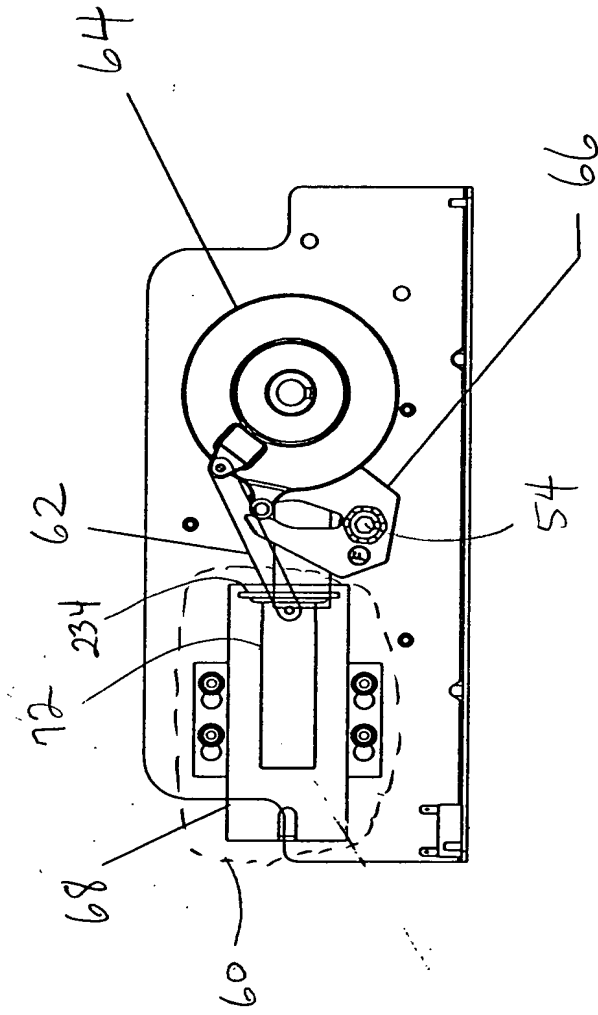


Fig. 14

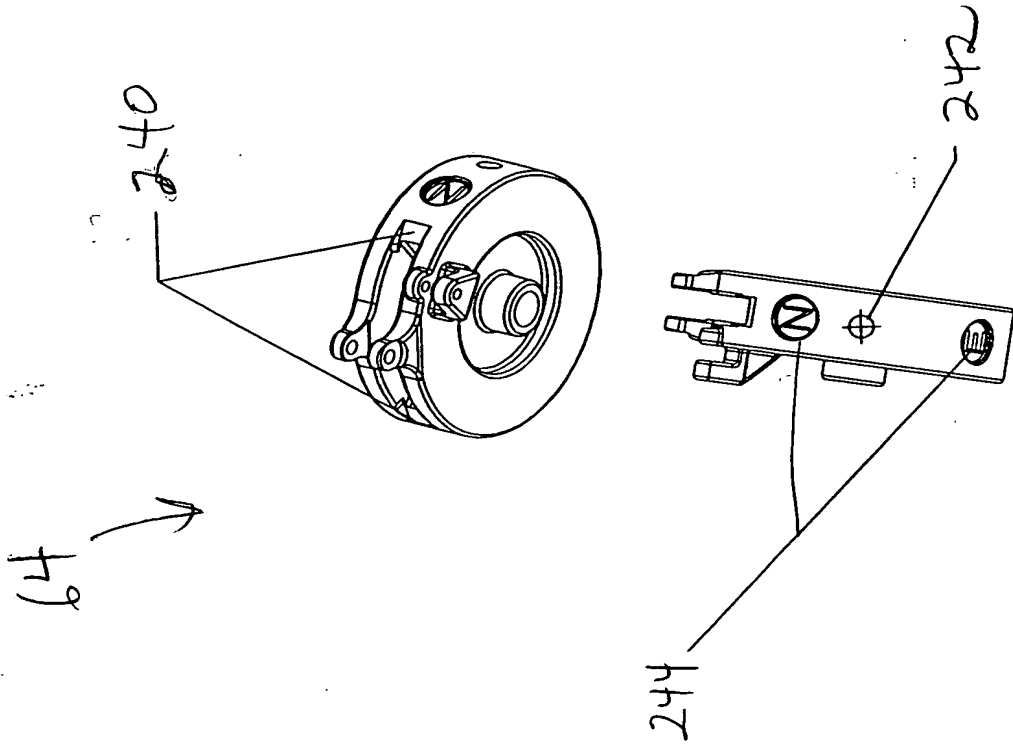


Fig. 15

Fig. 16

FIG. 17

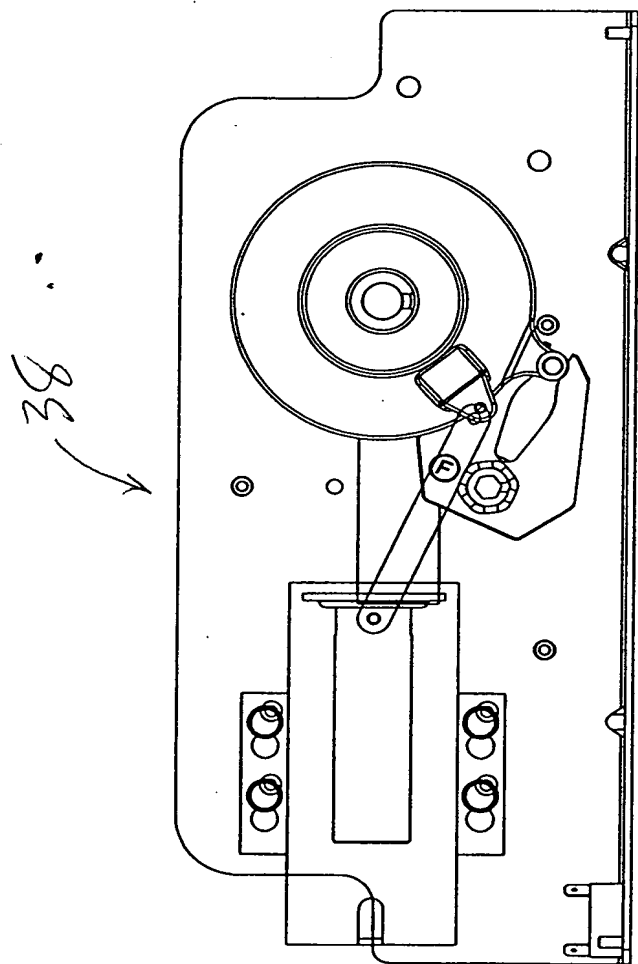


Fig. 17

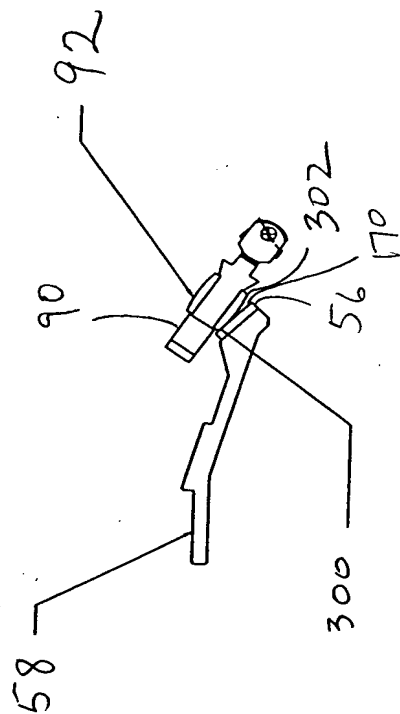


Fig. 18